S1DALH - S1MALH

Taiwan Semiconductor

1A, 200V-1000V Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Freewheeling
- Snubber
- DC/DC converters
- Automotive application

MECHANICAL DATA

- Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.029g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	1	А	
V _{RRM}	200-1000	V	
I _{FSM}	30	А	
T _{J MAX}	150	°C	
Package	Thin SMA		
Configuration	Single Die		



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)							
PARAMETER	SYMBOL	S1DALH	S1GALH	S1JALH	S1KALH	S1MALH	UNIT
Marking code on the device		S1DAH	S1GAH	S1JAH	S1KAH	S1MAH	
Repetitive peak reverse voltage	V _{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	140	280	420	560	700	V
Forward current	I _F			1			А
Surge peak forward current, single half sine-wave superimposed on rated loadt = 8.3mst = 1.0ms	-			30			А
	S I _{FSM}			100			А
Junction temperature	TJ			-55 to +150)		°C
Storage temperature	T _{STG}			-55 to +150)		°C





THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance	R _{ejl}	29	°C/W	
Junction-to-ambient thermal resistance	R _{eja}	82	°C/W	
Junction-to-case thermal resistance	R _{eJC}	30	°C/W	

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 0.5A, T_J = 25^{\circ}C$	V _F	0.90	-	V
	$I_F = 1.0A, T_J = 25^{\circ}C$		0.96	1.10	V
	$I_F = 0.5A, T_J = 125^{\circ}C$		0.78	-	V
	$I_F = 1.0A, T_J = 125^{\circ}C$		0.85	0.98	V
Reverse current @ rated $V_R^{(2)}$	T _J = 25°C	I _R	-	1	μA
	T _J = 125°C		-	50	μA
Junction capacitance	1MHz, V _R = 4.0V	CJ	8	-	pF

Notes:

- (1) Pulse test with PW = 0.3ms
- (2) Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING	
S1xALH M3G	Thin SMA	3,500 / 7" reel	
S1xALH M2G	Thin SMA	14,000 / 13" reel	

Notes:

(1) "x" defines voltage from 200V(S1DALH) to 1000V(S1MALH)



f=1.0MHz Vsig=50mVp-p

100

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

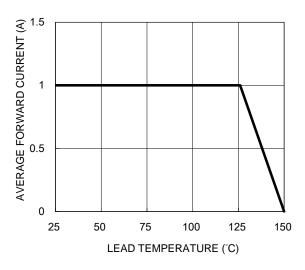
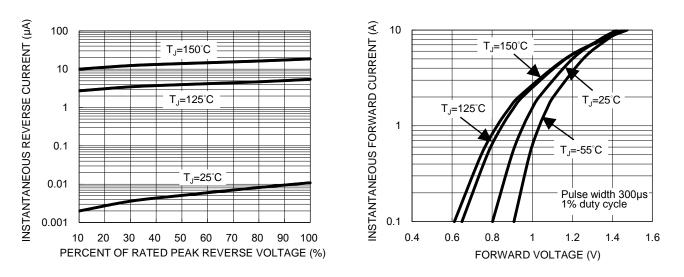


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics



100

10

1

0.1

1

CAPACITANCE (pF)

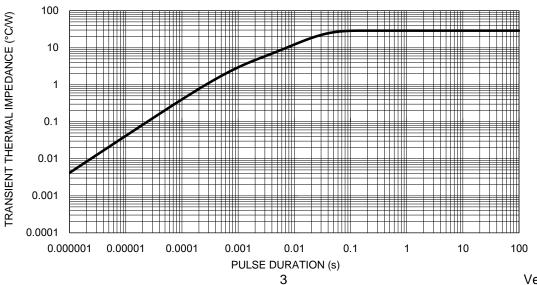


Fig.5 Typical Transient Thermal Impedance

Fig.2 Typical Junction Capacitance

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REVERSE VOLTAGE (V)

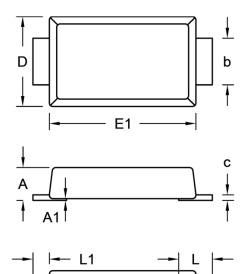
Fig.4 Typical Forward Characteristics

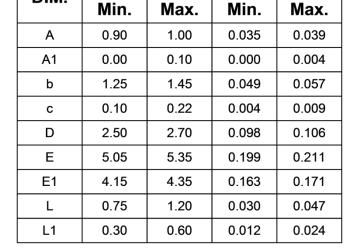


Unit (inch)

PACKAGE OUTLINE DIMENSIONS

Thin SMA



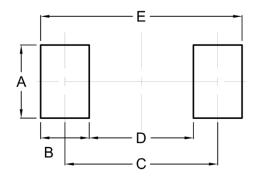


Unit (mm)

DIM.

SUGGESTED PAD LAYOUT

– E



Symbol	Unit (mm)	Unit (inch)
A	2.10	0.083
В	1.40	0.055
С	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N	= Marking Code
YW	= Date Code
F	= Factory Code



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